

BGM781N11E6327XUSA1

BGM781N11E6327XUSA1 Information



For Reference Only

Part NumberBGM781N11E6327XUSA1ManufacturerInfineon TechnologiesCategoryRF/IF and RFID

RF Front End (LNA + PA)

Description MODULE GPS FRONT-END TSNP-11-2

Package 10-WFDFN Exposed Pad

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









BGM781N11E6327XUSA1 Specifications

Manufacturer Part Number	BGM781N11E6327XUSA1
Manufacturer	Infineon Technologies
Category	RF/IF and RFID
	RF Front End (LNA + PA)
Package	10-WFDFN Exposed Pad
Series	-
RF Type	GPS
Frequency	1575.42MHz
Features	-
Package / Case	10-WFDFN Exposed Pad
Supplier Device Package	PG-TSNP-11
	Report errors?

BGM781N11E6327XUSA1 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

BGM781N11E6327XUSA1 Payment Methods



















BGM781N11E6327XUSA1 Shipping Methods













If you have any question about BGM781N11E6327XUSA1, please do not hesitate to contact us!

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